Product Specification

400G QSFP-DD to 4x100G QSFP56 Passive Breakout Direct Attach Copper Cable

P/N: 400G-QDD-4Q-CU

Features

- Supporting 400Gbps to 4x100Gbps
- Wire AWG:30AWG,28AWG
- Available length range 1m~3m
- Data rates per channel 53.125Gbps
- Operating data rate 425Gbps
- Power supply: +3.3V
- Max power dissipation <0.1W
- Commercial temperature range 0°C to 70°C
- High-Density QSFP-DD 76-PIN and 4x QSFP56 38-PIN
 Connector
- I2C based two-wire serial interface for EEPROM signature which can be customized

Compliance

- Compliant with QSFP-DD MSA and QSFP56 MSA
- SFF-8665 QSFP+ 28G 4X Pluggable Transceiver Solution(QSFP28)
- IEEE802.3bj,IEEE802.3cd
- RoHS

Applications

- 400/100 Gigabit Ethernet
- High Performance Computing (HPC)
- Data Center & Networking Equipment
- Low cost network upgrade



Description

The 400G-QDD-4Q-CU is a high-performance, cost-effective solution designed to simplify connectivity in modern data centers and high-speed networks. This cable enables a single 400G QSFP-DD port to be split into four independent 100G QSFP56 ports, providing a flexible and efficient way to maximize port utilization and optimize network infrastructure. It is ideal for high-density 100G applications, such as interconnecting top-of-rack switches, leaf-spine architectures, or high-performance computing environments.

Constructed with high-quality copper cables, this breakout DAC ensures reliable, low-latency data transmission over short distances, making it a practical alternative to optical solutions for in-rack or adjacent-rack connections. Its plug-and-play design simplifies deployment, while its robust construction ensures durability and long-term performance in demanding environments. Compliant with industry standards, including IEEE 802.3bs and QSFP-DD MSA, the cable guarantees seamless interoperability with a wide range of networking equipment.

Product performance Specifications

1. Basic Product Characteristics

Parameter	Symbol	Min	Тур.	Мах	Unit
Storage Temperature	Ts	-40		85	°C
Operating Case Temperature	Tc	0		70	°C
Relative Humidity	RH	5		85	%
Supply Voltage	Vcc	-0.3	3.3	3.6	V
Data Rate	DR		425		Gbp/s

2. High Speed Characteristics

Parameter	Symbol	Min	Тур.	Мах	Unit	Unit
Differential Impedance	TDR	90	100	110	Ω	
Insertion loss	SDD21	-17.16			dB	13.28 GHz
Differential Return Loss	SDD11	-16.5 +	2 × SQRT(f), with	h f in GHz	dB	0.05 to 4.1 GHz
Differential Return Loss	SDD22	-10.66 + 1	14 × log10(f/5.5), v	with f in GHz		4.1 to 19 GHz
Common-mode to common-mode output return loss	SCC11 SCC22			-2	dB	0.2 to 19 GHz
Differential to common-mode	SCD11	-22 +	(20/25.78)*f, with	f in GHz	dB	0.01 to 12.89
return loss	SCD22	-15 +	(6/25.78)*f, with f	in GHz		GHz
Differential to common Mode Conversion Loss	SCD21-IL			-10		0.01 to 12.89 GHz

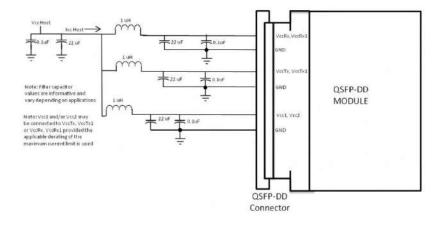


-27 + (29/22)*f, with f	in GHz	dB	12.89 to 15.7 GHz
	-6.3		15.7 to 19 GHz

3. Product Optical and Electrical Characteristics

Test Type	Test Item	24AWG	26AWG	28AWG	30AWG
	Differential impedance	$100\pm5\Omega$ at TDR	100±5Ω	100±5Ω	100±5Ω at TDR
	Mutual capacitance	14pF/ft nominal	14pF/ft nominal	14pF/ft nominal	14pF/ft nominal
	Time delay	1.31ns/ft nominal, (4.3ns/m) nominal	1.35ns/ft nominal	1.35ns/ft nominal	1.35ns/ft nominal, (4.3ns/m) nominal
Electrical	Time delay skew (within pairs)	80ps/10m maximum	120ps/8.5m maximum	120ps/7m maximum	50ps/5.5m maximum
Characteristics	Time delay skew (between pairs)	350ps/10m maximum	500ps/8.5m maximum	500ps/7m maximum	350ps/5.5m maximum
	Attenuation	10dB/10m maximum at 1.25Ghz	10dB/8.5m maximum at 1.25Ghz	10dB/7m maximum at 1.25Ghz	8.4dB/5.5m maximum at 1.25Ghz
	Conductor DC Resistance	0.026Ω /ft maximum at 20°C	0.04Ω /ft maximum at 20°C	0.06Ω/ft maximum at 20°C	0.01Ω/ft maximum at 20°C
	Conductors (two pair)	24AWG Solid, Silver plated copper	26AWG Solid, Silver plated copper	28AWG Solid, Silver plated copper	30AWG Solid, Silver plated copper
	Insulation	Foam polyolefin	Foam polyolefin	Foam polyolefin	Foam polyolefin
	Pair drain wire	26AWG Solid, Silver plated copper	28AWG Solid, Silver plated copper	30AWG Solid, Silver plated copper	30AWG Solid, Silver plated copper
Physical Characteristics	Overall cable shield	Aluminum/polyester tape, 125% coverage, Tin plated copper braid, 38AWG, 85% coverage	Aluminum/polyester tape, 125% coverage, Tin plated copper braid, 38AWG, 85% coverage	Aluminum/polyest er tape, 125% coverage,Tin plated copper braid, 38AWG, 85% coverage	Aluminum/polyester tape, 125% coverage,Tin plated copper braid, 38AWG, 85% coverage
	Outer diameter	6.0mm	5.2mm	4.7mm	4.2mm

Recommended Host Board Power Supply Circuit





Recommended Interface Circuit

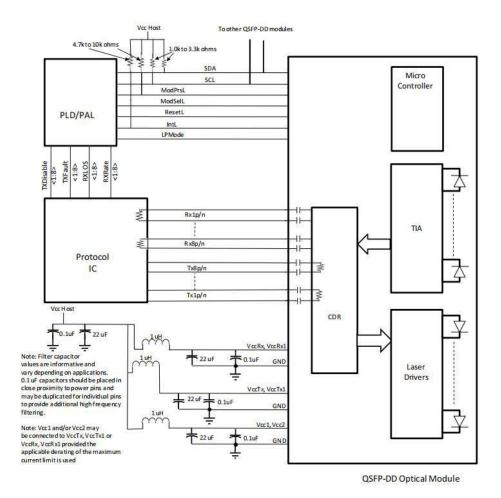


Figure2:Recommended Interface Circuit

QSFP-DD Pin-out Definition

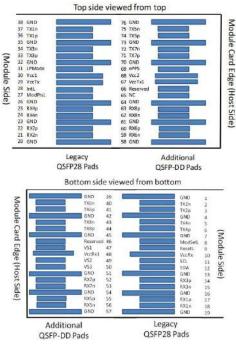


Figure3:QSFP-DD Pin view

QSFP-DD Pin Function Definitions

Pin	Logic	Symbol	Description	Note
1		GND	Ground	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	
4		GND	Ground	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	
7		GND	Ground	1
8	LVTTL-I	ModSelL	Module Select	
9	LVTTL-I	ResetL	Module Reset	
10		Vcc Rx	+3.3V Power Supply Receiver	2
11	LVCMOS-I/O	SCL	2-wire serial interface clock	
12	LVCMOS-I/O	SDA	2-wire serial interface data	
13		GND	Ground	1
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	
15	CML-O	Rx3n	Receiver Inverted Data Output	
16		GND	Ground	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	



18	CML-O	Rx1n	Receiver Inverted Data Output	
19	OINIL-O	GND	Ground	1
20		GND	Ground	1
20	CML-O	Rx2n	Receiver Inverted Data Output	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	
23	OWIE-O	GND	Ground	1
24	CML-O	Rx4n	Receiver Inverted Data Output	
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	
26	OWIE-0	GND	Ground	1
27	LVTTL-O	ModPrsL	Module Present	·
28	LVTTL-O	IntL/RxLOSL	Interrupt. Optionally configurable as RxLOSL via the management interface (SFF-8636)	
29		VccTx	+3.3V Power supply transmitter	2
30		Vcc1	+3.3V Power supply	2
31	LVTTL-I	InitMode	Initialization mode; In legacy QSFP applications, the InitMode pad is called LPMODE	
32		GND	Ground	1
33	CML-I	Тх3р	Transmitter Non-Inverted Data Input	
34	CML-I	Tx3n	Transmitter Inverted Data Input	
35		GND	Ground	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	
37	CML-I	Tx1n	Transmitter Inverted Data Input	
38		GND	Ground	1
39		GND	Ground	1
40	CML-I	Tx6n	Transmitter Inverted Data Input	
41	CML-I	Тх6р	Transmitter Non-Inverted Data Input	
42		GND	Ground	1
43	CML-I	Tx8n	Transmitter Inverted Data Input	
44	CML-I	Tx8p	Transmitter Non-Inverted Data Input	
45		GND	Ground	1
46		Reserved	For future use	3
47		VS1	Module Vendor Specific 1	3
48		VccRx1	3.3V Power Supply	2
49		VS2	Module Vendor Specific 2	3
50		VS3	Module Vendor Specific 3	3
51		GND	Ground	1
52	CML-O	Rx7p	Receiver Non-Inverted Data Output	
53	CML-O	Rx7n	Receiver Inverted Data Output	
54		GND	Ground	1
55	CML-O	Rx5p	Receiver Non-Inverted Data Output	
56	CML-O	Rx5n	Receiver Inverted Data Output	
57		GND	Ground	1



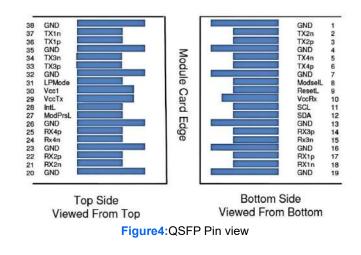
58		GND	Ground	1
59	CML-O	Rx6n	Receiver Inverted Data Output	
60	CML-O	Rx6p	Receiver Non-Inverted Data Output	
61		GND	Ground	1
62	CML-O	Rx8n	Receiver Inverted Data Output	
63	CML-O	Rx8p	Receiver Non-Inverted Data Output	
64		GND	Ground	1
65		NC	No Connect	3
66		Reserved	For future Use	3
67		VccTx1	3.3V Power Supply	2
68		Vcc2	3.3V Power Supply	2
69		Reserved	For future Use	3
70		GND	Ground	1
71	CML-I	Tx7p	Transmitter Non-Inverted Data Input	
72	CML-I	Tx7n	Transmitter Inverted Data Input	
73		GND	Ground	1
74	CML-I	Tx5p	Transmitter Non-Inverted Data Input	
75	CML-I	Tx5n	Transmitter Inverted Data Input	
76		GND	Ground	1

Note1: QSFP-DD uses common ground (GND)for all signals and supply (power). All are common within the QSFP-DD module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.

Note2: VccRx, VccRx1, Vcc1, Vcc2, VccTx and VccTx1 shall be applied concurrently. Requirements defined for the host side of the Host Card Edge Connector are listed in Table 6. VccRx, VccRx1, Vcc1, Vcc2, VccTx and VccTx1 may be internally connected within the module in any combination. The connector Vcc pins are each rated for a maximum current of 1000 mA.

Note3: All Vendor Specific, Reserved and No Connect pins may be terminated with 50 ohms to ground on the host. Pad 65 (No Connect) shall be left unconnected within the module. Vendor specific and Reserved pads shall have an impedance to GND that is greater than 10 Kohms and less than 100 pF.

QSFP Pin-out Definition





QSFP Pin Function Definitions

Pin	Logic	Symbol	Description	Note
1		GND	Ground	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	3
4		GND	Ground	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	3
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	3
7		GND	Ground	1
8	LVTTL-I	ModSelL	Module Select	4
9	LVTTL-I	ReSelL	Module Select	4
10		Vcc Rx	+3.3V Power Supply Receiver	2
11	LVCMOS-I/O	SCL	2-wire serial interface clock	4
12	LVCMOS-I/O	SDA	2-wire serial interface data	4
13		GND	Ground	1
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	3
15	CML-O	Rx3n	Receiver Inverted Data Output	3
16		GND	Ground	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3
18	CML-O	Rx1n	Receiver Inverted Data Output	3
19		GND	Ground	1
20		GND	Ground	1
21	CML-O	Rx2n	Receiver Inverted Data Output	3
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3
23		GND	Ground	1
24	CML-O	Rx4n	Receiver Inverted Data Output	3
25	CML-O	Rx4p	Receiver Non-Inverted Data Output Ground	3
26		GND	Ground	1
27	LVTTL-O	ModPrsL	Module Present	4
28	LVTTL-O	IntL	Interrupt	4
29		Vcc Tx	+3.3V Power supply transmitter	2
30		Vcc1	+3.3V Power supply	2
31	LVTTL-I	LPMode	Low Power Mode	4
32		GND	Ground	1
33	CML-I	Тх3р	Transmitter Non-Inverted Data Input	3
34	CML-I	Tx3n	Transmitter Inverted Data Input	3
35		GND	Ground	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3
37	CML-I	Tx1n	Transmitter Inverted Data Input	3
38		GND	Ground	1

Note1: GND is the symbol for signal and supply (power) common for the QSFP+ module. All are common within the QSFP+ module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

Note2: Vcc Rx, Vcc1 and Vcc Tx are the receiver and transmitter power supplies and shall be applied concurrently. Requirements defined for the host side of the Host Edge Card Connector are listed in Table. Recommended host board power supply filtering is shown in Host board power supply circuit. Vcc Rx Vcc1 and Vcc Tx may be internally connected within the QSFP module in any combination. The connector pins are each rated for a maximum current of 500 mA.

Note3: High-speed signal interfaces require differential pairs (e.g. TX1+/TX1-) with tightly matched impedances (typically 100Ω).

Note4: The management and control signals are based on LVTTL level logic and are used for functions such as module selection and reset.

QSFP-DD Monitoring Specification

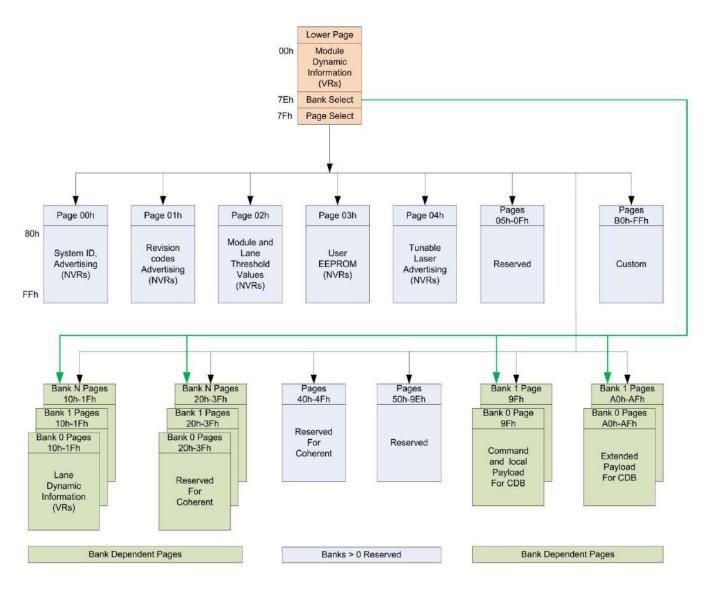


Figure5:QSFP-DD Memory map



QSFP-DD Memory map Table

Byte	Unit	Name	Description
		Lo	wer Page 00h
0	1	Identifier	Identifier - Type of Serial Module - See SFF-8024.
			Identifier - CMIS revision; the upper nibble is the whole number part
1	1	Revision Compliance	and the lower nibble is the decimal part.
			Example: 01h indicates version 0.1, 21h indicates version 2.1.
2-3	2	ID and Status Area	Flat mem indication, CLEI present indicator, Maximum TWI speed, Current state of Module, Current state of the Interrupt signal.
4-7	4	Lane Flag Summary	Flag summary of all lane flags on pages 10h-1Fh.
8-13	6	Module-Level Flags	All flags that are not lane or data path specific.
14-25	12	Module-Level Monitors	Monitors that are not lane or data path specific.
26-30	5	Module Global Controls	Controls applicable to the module as a whole
31-36	6	Module-Level Flag Masks	Masking bits for the Module-Level flags
37-38	2	CDB Status Area	Status of most recent CDB command
39-40	2	Module Firmware Version	Module Firmware Version.
41-63	23	Reserved Area	Reserved for future standardization
64-82	19	Custom Area	Vendor or module type specific use
00.04	0	la setion Financian Manian	Version Number of Inactive Firmware. Values of 00h indicates
83-84	2	Inactive Firmware Version	module supports only a single image.
85-117	33	Application Advertising	Combinations of host and media interfaces that are supported by
			module data path(s)
118-125	8	Password Entry and Change	Password Entry and Change
126	1	Bank Select Byte	Bank address of currently visible Page
127	1	Page Select Byte	Page address of currently visible Page
			per Page 00h
128	1	Identifier	Identifier - Type of Serial Module - See SFF-8024.
129-144	16	Vendor name	Vendor name (ASCII)
145-147	2	Vendor OUI	Vendor IEEE company ID
148-163	16	Vendor PN	Part number provided by vendor (ASCII)
164-165	8	Vendor rev	Revision level for part number provided by vendor (ASCII)
166-181	10	Vendor SN	Vendor Serial Number (ASCII)
182-183	2	Date code year	ASCII code, two low order digits of year (00=2000)
184-185	2	Date code month	ASCII code digits of month (01=Jan through 12=Dec)
186-187	2	Date code day of month	ASCII code day of month (01-31)
188-189	2	Lot code	ASCII code, custom lot code, may be blank
190-199	10	CLEI code	Common Language Equipment Identification code



200-201	2	Module power characteristics	Module power characteristics
202	1	Cable assembly length	Cable assembly length
203	1	Media Connector Type	Media Connector Type
204	1	5 GHz attenuation	Passive copper cable attenuation at 5 GHz in 1 dB increments
205	1	7 GHz attenuation	Passive copper cable attenuation at 7 GHz in 1 dB increments
206	1	12.9 GHz attenuation	Passive copper cable attenuation at 12.9 GHz in 1 dB increments
207	1	25.8 GHz attenuation	Passive copper cable attenuation at 25.8 GHz in 1 dB increments
208-209	2	Reserved	Reserved
210-211	2	Cable Assembly Lane Information	Cable Assembly Lane Information
212	1	Media Interface Technology	Media Interface Technology
213-220	8	Reserved	Reserved
221	1	Custom	Custom
222	1	Checksum	Includes bytes 128-221
223-255	33	Custom Info NV	Custom Info NV

QSFP Monitoring Specification

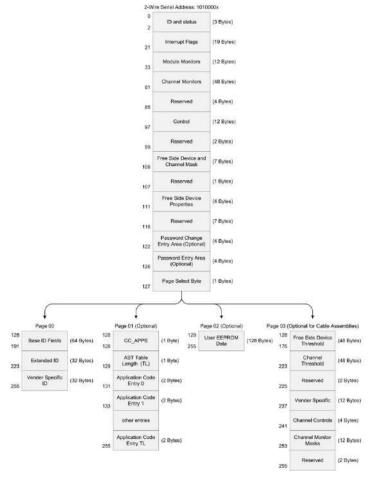


Figure6:QSFP Memory map



QSFP Memory map Table

Byte	Unit	Name	Description
			Lower Page 00h
0	1	Identifier	Type of transceiver,Page 00h Byte 0 and Page 00h Byte 128 shall contain the same parameter values.
1	1	Status	Revision Compliance
2	1	Status	Status indicators
3-21	19	Interrupt Flags	Consist of interrupt flags for LOS, Tx Fault, warnings and alarms. The non-asserted state shall be 0b.
22	1	Temperature MSB	Internally measured temperature (MSB)
23	1	Temperature LSB	Internally measured temperature (LSB)
24-25	2	Reserved	Reserved
26	1	Supply Voltage MSB	Internally measured supply voltage (MSB)
27	1	Supply Voltage LSB	Internally measured supply voltage (LSB)
28-29	2	Reserved	Reserved
30-33	4	Vendor Specific	Vendor Specific
34	1	Rx1 Power MSB	Internally measured Rx1 input power
35	1	Rx1 Power LSB	
36	1	Rx2 Power MSB	Internally measured Rx2 input power
37	1	Rx2 Power LSB	
38	1	Rx3 Power MSB	Internally measured Rx3 input power
39	1	Rx3 Power LSB	
40	1	Rx4 Power MSB	Internally measured Rx4 input power
41	1	Rx4 Power LSB	
42	1	Tx1 Bias MSB	Internally measured Tx1 bias
43	1	Tx1 Bias LSB	
44	1	Tx2 Bias MSB	Internally measured Tx2 bias
45	1	Tx2 Bias LSB	
46	1	Tx3 Bias MSB	Internally measured Tx3 bias
47	1	Tx3 Bias LSB	
48	1	Tx4 Bias MSB	Internally measured Tx4 bias
49	1	Tx4 Bias LSB	
50	1	Tx1 Power MSB	Internally measured Tx1 Power
51	1	Tx1 Power LSB	
52	1	Tx2 Power MSB	Internally measured Tx2 Power
53	1	Tx2 Power LSB	
54	1	Tx3 Power MSB	Internally measured Tx3 Power
55	1	Tx3 Power LSB	



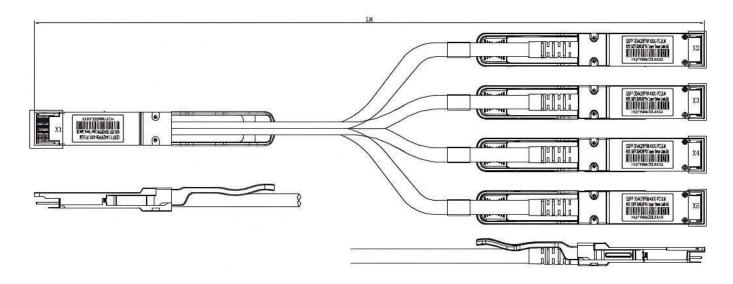
56	1	Tx4 Power MSB	Internally measured Tx4 Power
57	1	Tx4 Power LSB	
58-65	8	Reserved	Reserved channel monitor set 4
66-73	8	Reserved	Reserved channel monitor set 5
74-81	8	Vendor Specific	Vendor Specific
82-85	4	Reserved	Reserved
86-99	14	Control	Control
100-106	7	Free Side Device and Channel Masks	Free Side Device and Channel Masks
107-110	4	Free Side Device Properties	Free Side Device Properties
		Assigned for use by	Used for:
111-112	2	Assigned for use by PCI Express	- The PCI Express External Cable Specification
		P CI Expless	- The PCI Express OCuLink Specification
113-117	4	Free Side Device Properties	Free Side Device Properties
118	1	Reserved	Reserved
119-122	4	Password Change Entry Area	Password Change Entry Area
123-126	4	Password Entry Area	Password Entry Area
127	1	Page Select Byte	Page Select Byte
127	1	Page Select Byte	Page Select Byte Upper Page 00h
127 128	1	Page Select Byte	
			Upper Page 00h
128	1	Identifier	Upper Page 00h Identifier Type of free side device.(See SFF-8024 Transceiver Management) Extended Identifier of free side device. Includes power classes, CLEI codes,
128 129	1	Identifier Ext. Identifier	Upper Page 00h Identifier Type of free side device.(See SFF-8024 Transceiver Management) Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability.
128 129 130	1 1 1	Identifier Ext. Identifier Connector Type Specification	Upper Page 00h Identifier Type of free side device.(See SFF-8024 Transceiver Management) Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability. Code for media connector type. (See SFF-8024 Transceiver Management)
128 129 130 131-138	1 1 1 8	Identifier Ext. Identifier Connector Type Specification Compliance	Upper Page 00h Identifier Type of free side device.(See SFF-8024 Transceiver Management) Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability. Code for media connector type. (See SFF-8024 Transceiver Management) Code for electronic or optical compatibility. Code for serial encoding algorithm. (See SFF-8024 Transceiver
128 129 130 131-138 139	1 1 1 8 1	Identifier Ext. Identifier Connector Type Specification Compliance Encoding Signaling rate,	Upper Page 00hIdentifier Type of free side device.(See SFF-8024 Transceiver Management)Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability.Code for media connector type. (See SFF-8024 Transceiver Management)Code for electronic or optical compatibility.Code for serial encoding algorithm. (See SFF-8024 Transceiver Management)Nominal signaling rate, units of 100 MBd. For rate > 25.4 GBd, set this to FFh
128 129 130 131-138 139 140	1 1 1 8 1 1	Identifier Identifier Ext. Identifier Connector Type Specification Compliance Encoding Signaling rate, nominal Extended Rate	Upper Page 00h Identifier Type of free side device.(See SFF-8024 Transceiver Management) Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability. Code for media connector type. (See SFF-8024 Transceiver Management) Code for electronic or optical compatibility. Code for serial encoding algorithm. (See SFF-8024 Transceiver Management) Nominal signaling rate, units of 100 MBd. For rate > 25.4 GBd, set this to FFh and use Byte 222.
128 129 130 131-138 139 140 141	1 1 1 8 1 1 1	IdentifierExt. IdentifierConnector TypeSpecificationComplianceEncodingSignaling rate, nominalExtended Rate Select Compliance	Upper Page 00hIdentifier Type of free side device.(See SFF-8024 Transceiver Management)Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability.Code for media connector type. (See SFF-8024 Transceiver Management)Code for electronic or optical compatibility.Code for serial encoding algorithm. (See SFF-8024 Transceiver Management)Nominal signaling rate, units of 100 MBd. For rate > 25.4 GBd, set this to FFh and use Byte 222.Tags for extended rate select compliance.Link length supported at the signaling rate in byte 140 or page 00h byte 222,
128 129 130 131-138 139 140 141 142	1 1 1 8 1 1 1 1 1	IdentifierIdentifierExt. IdentifierConnector TypeSpecificationComplianceEncodingSignaling rate, nominalExtended Rate Select ComplianceLength (SMF)Length (OM3 50	Upper Page 00h Identifier Type of free side device. (See SFF-8024 Transceiver Management) Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability. Code for media connector type. (See SFF-8024 Transceiver Management) Code for electronic or optical compatibility. Code for serial encoding algorithm. (See SFF-8024 Transceiver Management) Nominal signaling rate, units of 100 MBd. For rate > 25.4 GBd, set this to FFh and use Byte 222. Tags for extended rate select compliance. Link length supported at the signaling rate in byte 140 or page 00h byte 222, for SMF fiber in km *. A value of 1 shall be used for reaches from 0 to 1 km. Link length supported at the signaling rate in byte 140 or page 00h byte 222,
128 129 130 131-138 139 140 141 142 142 143	1 1 1 8 1 1 1 1 1 1	IdentifierIdentifierExt. IdentifierConnector TypeSpecificationComplianceEncodingSignaling rate, nominalExtended Rate Select ComplianceLength (SMF)Length (OM3 50 um)Length (OM2 50	Upper Page 00h Identifier Type of free side device. (See SFF-8024 Transceiver Management) Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability. Code for media connector type. (See SFF-8024 Transceiver Management) Code for electronic or optical compatibility. Code for serial encoding algorithm. (See SFF-8024 Transceiver Management) Nominal signaling rate, units of 100 MBd. For rate > 25.4 GBd, set this to FFh and use Byte 222. Tags for extended rate select compliance. Link length supported at the signaling rate in byte 140 or page 00h byte 222, for SMF fiber in km *. A value of 1 shall be used for reaches from 0 to 1 km. Link length supported at the signaling rate in byte 140 or page 00h byte 222, for EBW 50/125 um fiber (OM3), units of 2 m * Link length supported at the signaling rate in byte 140 or page 00h byte 222, for EBW 50/125 um fiber (OM3), units of 2 m *

LS&LINK

		um) or Copper	for 62.5/125 um fiber (OM1), units of 1 m *, or copper cable attenuation in dB $$		
		Cable Attenuation	at 25.78 GHz.		
146	1	Length (passive copper or active cable or OM4 50 um)	Length of passive or active cable assembly (units of 1 m) or link length supported at the signaling rate in byte 140 or page 00h byte 222, for OM4 50/125 um fiber (units of 2 m) as indicated by Byte 147. See 6.3.12.		
147	1	Device technology	Device technology		
148-163	16	Vendor name	Free side device vendor name (ASCII)		
164	1	Extended Module	Extended Module codes for InfiniBand.		
165-167	3	Vendor OUI	Free side device vendor IEEE company ID.		
168-183	16	Vendor PN	Part number provided by free side device vendor(ASCII)		
184-185	2	Vendor rev	Revision level for part number provided by the vendor(ASCII)		
186-187	2	Wavelength or Copper Cable Attenuation	Nominal laser wavelength (wavelength=value/20 in nm) or copper cable attenuation in dB at 2.5 GHz (Byte 186) and 5.0 GHz (Byte 187)		
188-189	2	Wavelength	The range of laser wavelength (+/- value) from nominal wavelength.		
		tolerance or Copper Cable Attenuation	(wavelength Tol. =value/200 in nm) or copper cable attenuation in dB at 7.0 GHz (Byte 188) and 12.9 GHz (Byte 189)		
190	1	Max case temp			
		Max case lenip	Maximum case temperature		
191	1	CC_BASE	Check code for base ID fields (Bytes 128-190)		
191 192					
	1	CC_BASE	Check code for base ID fields (Bytes 128-190)		
192	1 1	CC_BASE Link codes	Check code for base ID fields (Bytes 128-190) Extended Specification Compliance Codes (See SFF-8024)		
192 193-195	1 1 3	CC_BASE Link codes Options	Check code for base ID fields (Bytes 128-190) Extended Specification Compliance Codes (See SFF-8024) Optional features implemented.		
192 193-195 196-211	1 1 3 16	CC_BASE Link codes Options Vendor SN	Check code for base ID fields (Bytes 128-190) Extended Specification Compliance Codes (See SFF-8024) Optional features implemented. Serial number provided by vendor.(ASCII)		
192 193-195 196-211 212-219	1 1 3 16 8	CC_BASE Link codes Options Vendor SN Date Code Diagnostic	Check code for base ID fields (Bytes 128-190) Extended Specification Compliance Codes (See SFF-8024) Optional features implemented. Serial number provided by vendor.(ASCII) Vendor's manufacturing date code. Indicates which type of diagnostic monitoring is implemented (if any) in the		
192 193-195 196-211 212-219 220	1 1 3 16 8 1	CC_BASE Link codes Options Vendor SN Date Code Diagnostic Monitoring Type	Check code for base ID fields (Bytes 128-190) Extended Specification Compliance Codes (See SFF-8024) Optional features implemented. Serial number provided by vendor.(ASCII) Vendor's manufacturing date code. Indicates which type of diagnostic monitoring is implemented (if any) in the free side device. Bit 1,0 Reserved. Indicates which optional enhanced features are implemented in the free side		
192 193-195 196-211 212-219 220 221	1 1 3 16 8 1 1	CC_BASELink codesOptionsVendor SNDate CodeDiagnosticMonitoring TypeEnhanced Options	Check code for base ID fields (Bytes 128-190) Extended Specification Compliance Codes (See SFF-8024) Optional features implemented. Serial number provided by vendor.(ASCII) Vendor's manufacturing date code. Indicates which type of diagnostic monitoring is implemented (if any) in the free side device. Bit 1,0 Reserved. Indicates which optional enhanced features are implemented in the free side device.		



Mechanical Dimension



Note:

- Unit: mm
- Tolerance: φ0.1mm if not shown
- Latch color: black
- When L<2m, the tolerance is ± 25 mm, when L>2m, the tolerance is ± 50 mm

Waring:

- The transceiver optics is supplied with a dust cover. This plug protects the transceiver optics during standard manufacturing processes by preventing contamination from air borne particles. It is recommended that the dust cover remain in the transceiver whenever an optical fiber connector is not inserted.
- Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.
- Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.



Test Center

1. Performance Testing

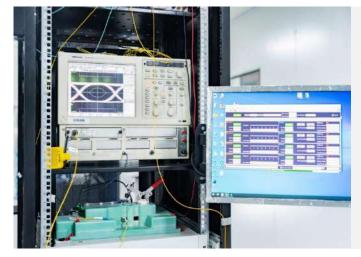
Every fiber optic transceiver is thoroughly tested by the LSOLINK Assurance Program, which is equipped with the world's most advanced analytical equipment to ensure that our transceivers meet the industry's international public protocol standards while still functioning flawlessly in your facility.



Optical Spectrum Inspection

Using the industry's leading optical spectrum analyser to check in real time that the parameters of the optical transceiver's laser comply with industry standards.

- Peak: Peak wavelength and peak level
- 2nd Peak: Side-mode wavelength and level
- Mean WI: Center wavelength
- > Total Power: Total power of spectrum
- SMSR: Side-Mode Suppression Ratio



Optical Signal Quality Inspection

Using highly efficient sampling oscilloscopes and BERT testers, equipped with an automated test platform to accurately test the signal quality of the transceiver, test records are kept for up to 5 years to ensure the traceability of each transceiver.

- Eye Mask Margin(NRZ)
- > TDECQ(PAM4):transmitter dispersion eye closure
- OMA: Optical modulation amplitude
- BER: Bit error rate
- ER: Extinction Ratio



Flow Pressure Test

Using multi-protocol network traffic analyser with various brands of switches to test the transceiver's ability to transmit at full speed.

- **Bandwidth:** Actual transceiver bandwidth on the port
- Packet Loss
- Packet Errors:CRC Errors/PCS Errors/Symbol Errors
- LinkDown Counts
- > latency

Aboveis part of our test bed network equipment. For more information, Please click <u>download</u> for optical transceiver performance test report.



2. Quality Control

We adopt advanced quality management solutions. Each transceiver is self-inspected, including:20x microscope inspection, 200x microscope inspection, and QC process inspection.



visual inspection



Microscopic inspection: 20X



Microscopic inspection: 200X



Reliability Verification



Optical endface inspection



OQC Inspection



Order Information

Part Number	Length(m)	Wire Gauge(AWG)	Connector Type	Cable Type	Cable Jacket
400G-QDD-4Q-CU1	1	30	QSFP-DD to 4xQSFP56	Passive Copper	PVC
400G-QDD-4Q-CU1.5	1.5	30	QSFP-DD to 4xQSFP56	Passive Copper	PVC
400G-QDD-4Q-CU2	2	28	QSFP-DD to 4xQSFP56	Passive Copper	PVC
400G-QDD-4Q-CU2.5	2.5	28	QSFP-DD to 4xQSFP56	Passive Copper	PVC
400G-QDD-4Q-CU3	3	28	QSFP-DD to 4xQSFP56	Passive Copper	PVC



Further Information

Lighting the Path to Global Links

- Web | www.lsolink.com
- Email | For Sales@lsolink.com

Disclaimer

- We are committed to continuous product improvement and feature upgrades, and the contents cont ained in this manual are subject to change without notice.
- 2. Nothing herein should be construed as constituting an additional warranty.
- LSOLINK assumes no responsibility for the use or reliability of equipment or software not provided by LSOLINK. Copyright LSOLINK.COM All Rights